<table>
<thead>
<tr>
<th>PCB VIEWED FROM BOTTOM SIDE</th>
<th>BOARD #: PMP9184</th>
<th>REV: A</th>
<th>SUN REV: Not In VersionControl</th>
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</thead>
<tbody>
<tr>
<td></td>
<td></td>
<td></td>
<td>Ignore  →  Bottom Assembly Drawing</td>
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